CORRESPONDING TO RoHS DIRECTIVE 對應RoHS指令

(EU RoHS Directive 2011/65/EU)

Aluminum electrolytic capacitors		Chip type	Radial lead type	Snap-in terminal type	
鋁電解電容器		貼片式	引線式	導箔式	
RoHS compliant		Yes	Yes	Yes	
RoHS符合性		符合	符合	符合	
RoHS restricted substances 限制有害物質	The portion of the components 產品的部分特性 Plating on	Change plating from Sn-Pb to Sn 將鍍鉛錫合金變更為鍍錫			
Lead (Pb) 鉛	terminals 引線鍍層	Fe/Cu/Sn			
	Construction of terminals 引線結構	 Plating thickness 12μm Plating type matte No heat treatment after plating 鍍錫層厚度12μm 鍍錫層類型不光滑 鍍錫後無熱處理 	鍍錫銅包鐵線	 Plating thickness 10µm Plating type matte No heat treatment after plating 鈹錫層厚度10µm 鍍錫層類型不光滑 鍍錫後無熱處理 	
	Insulating sleeve 膠管	No used 不使用	Replace PVC with PET (where customer designated) 將PVC更換為PET (若客戶指定)		
	Resistance to soldering heat 耐焊接熱	Please refer to "Soldering Conditions" for chip type aluminum electrolytic capacitors 請參閱貼片式鋁電解電容器的 "焊接條件"	Correspondence to 260°C wave soldering condition 對應260°C的波峰焊接條件		
	Solderability 可焊性	No difference with Sn-Pb 與鉛錫線相同			
	Tensile strength 抗拉强度	No difference with Sn-Pb 與鉛錫線相同			
Hexavalent chromium (Cr VI)		Not detected			
六價鉻		未檢出			
Mercury (Hg)		Not detected			
汞		未檢出			
Cadmium (Cd)		Not detected			
鎘		未檢出			
Polybrominated biphenyls (PBBs)		Not detected			
多溴聯苯		未檢出			
Polybrominated diphenyl ethers (PBDEs)		Not detected			
多溴二苯醚		未檢出			
Hexabromocyclododecane (HBDD)		Not detected			
六溴環十二烷		未檢出			
Dibutyl phthalate (DBP)		Not detected			
鄰苯二甲酸二丁酯		未檢出			
Benzylbutyl phthalate (BBP)		Not detected			
鄰苯二甲酸丁苄酯		未檢出			
Bis-(2-ethylhexyl) phthalate (DEHP)		Not detected			
鄰苯二甲酸雙(2-乙基己)酯		未檢出			
Identification for RoHS compliance products RoHS符合性產品的識別		Added "Pb free" and "RoHS" symbol on inner and outer carton label 外箱和內箱上印有"PB free"和"RoHS"符號標識			
MSL Level 濕度敏感水平 (IPC/JEDEC J-STD-020C)		Not applicable 不適用			

COMPLIANCE FOR EU REACH REGULATION 遵循歐盟REACH法規

[EU REACH Regulation (EC) 1907/2006]

1) Registration of Substance:

According to the content of REACH handbook (Guidance on requirements of substances in articles which is published on May 2008), our products are "articles without any intended release". Therefore they are not applicable for "Registration" for EU REACH Regulation Article 7(1).

- 2) Correspondence with SVHC (Substances of Very High Concern):
 - Per the candidate list of SVHC-151 (Substances of Very High Concern) published December 2013, we have reviewed these substances and certify all Fujicon products are not intentionally used, no exposure of this material to humans.
- For any questions or comments regarding REACH, please contact our sales office.
- 1) 物質的註冊:

根據 REACH 法規手冊內容(2008 年 5 月公佈的物品中物質的要求),我們的產品是"沒有任何有意釋放的物品"。因此,我們的產品不適用 於歐盟 REACH 法規的第 7(1) 條的 "注册"。

- 2) 對應 SVHC(高度關注物質):
 - 對於 2013 年 12 月公佈的 SVHC-151(高關注物質)的候選清單,我們已審閱這些物質並證明我們的產品並無使用,以及此材料不暴露於人體。
- ■如對 REACH 有任何問題和意見,請與我們業務部門聯繫。

Note: All design and specifications are for reference only and is subject to change without prior notice. If any doubt about safety for your application, please contact us immediately for technical assistance before purchase.

注:以上所提供的設計及特性參數僅供參考,任何修改不作預先通知。如果在使用上有疑問,請在採購前與我們聯繫,以便提供技術上的協助。

CAT.2014/V5

CORRESPONDING TO RoHS DIRECTIVE 對應RoHS指令

(EU RoHS Directive 2011/65/EU)

Conductive Polymer Aluminus	m Solid Electrolytic Capacitors	Chip type	Radial lead type	
導電式高分子固	態鋁電解電容器	貼片式	插件式	
RoHS compliant RoHS符合性		Yes 符合	Yes 符合	
RoHS restricted substances 限制有害物質	The portion of the components 產品的部分特性	Sn plating 鍍錫引線		
	Plating on terminals 引線鍍層			
	Construction of terminals 引線結構	Fe/Cu/Sn 鍍錫銅包鐵線		
Lead (Pb) 鉛	Resistance to soldering heat 耐焊接熱	Please refer to "Soldering Conditions" for chip type conductive polymer aluminum solid electrolytic capacitors 請參閱貼片式導電高分子固態鉛電解電容器的"焊接條件"	Correspondence to 265°C wave soldering condition 對應265°C的波峰焊接條件	
	Solderability 可焊性	No difference with Sn-Pb 與鉛錫線相同		
	Tensile strength 抗拉强度	No difference with Sn-Pb 與鉛錫線相同		
Hexavalent ch 六信	romium (Cr VI) 賈鉻	Not detected 未檢出		
	ry (Hg) ₹	Not detected 未檢出		
Cadmium (Cd) 鎬		Not detected 未檢出		
Polybrominated l 多溴	biphenyls (PBBs) 聯苯	Not detected 未檢出		
Polybrominated diphenyl ethers (PBDEs) 多溴二苯醚		Not detected 未檢出		
六溴環	dodecane (HBDD) 十二烷	Not detected 未檢出		
	nalate (DBP) 酸二丁酯	Not detected 未檢出		
	hthalate (BBP) 酸丁苄酯	Not detected 未檢出		
Bis-(2-ethylhexyl) 鄰苯二甲酸雙	phthalate (DEHP) (2-乙基己)酯	Not detected 未檢出		
RoHS complia	ation for ance products 挂產品的識別	Added "Pb free" and "RoHS" symbol on inner and outer carton label 外箱和內箱上印有"PB free"和"RoHS"符號標識		
	Level 感水平 J-STD-020C)	Not applicable 不適用		

COMPLIANCE FOR EU REACH REGULATION 遵循歐盟REACH法規

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